



US0D1065154S

(12) **United States Design Patent**
Deng

(10) **Patent No.:** **US D1,065,154 S**

(45) **Date of Patent:** **** Mar. 4, 2025**

(54) **EARPHONE CASE AND EARPHONES**

Primary Examiner — Paula Allen Greene

(71) Applicant: **Yun Deng**, Guangdong Province (CN)

(57) **CLAIM**

(72) Inventor: **Yun Deng**, Guangdong Province (CN)

The ornamental design for an earphone case and earphones as shown and described.

(**) Term: **15 Years**

DESCRIPTION

(21) Appl. No.: **29/887,928**

(22) Filed: **Mar. 27, 2023**

(51) **LOC (15) Cl.** **14-01**

(52) **U.S. Cl.**

USPC **D14/223**; D3/274; D13/108

(58) **Field of Classification Search**

USPC D14/223; D13/108; D3/274, 294;
D24/174; 128/864-866; D9/420, 428

CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R 1/02;
H04R 5/033; H04R 5/0335; H04R
1/1105; H04R 1/1083; H02J 7/0044;
A45C 11/24; A45C 11/16; B65D 43/16

See application file for complete search history.

FIG. 1 is a perspective view of the earphone case and earphones showing my new design;

FIG. 2 is a front elevational view of the earphone case thereof, in a closed position, shown separately for clarity of illustration;

FIG. 3 is a rear elevational view thereof;

FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

FIG. 6 is a top plan view thereof;

FIG. 7 is a bottom plan view thereof;

FIG. 8 is a perspective view thereof;

FIG. 9 is a second perspective view thereof;

FIG. 10 is a third perspective view thereof;

FIG. 11 is a front elevational view of the left earphone thereof, shown separately for clarity of illustration;

FIG. 12 is a rear elevational view thereof;

FIG. 13 is a left side view thereof;

FIG. 14 is a right side view thereof;

FIG. 15 is a top plan view thereof;

FIG. 16 is a bottom plan view thereof;

FIG. 17 is a perspective view thereof;

FIG. 18 is a front elevational view of the right earphone thereof, shown separately for clarity of illustration;

FIG. 19 is a rear elevational view thereof;

FIG. 20 is a left side view thereof;

FIG. 21 is a right side view thereof;

FIG. 22 is a top plan view thereof;

FIG. 23 is a bottom plan view thereof; and,

FIG. 24 is a perspective view thereof.

The broken lines depict portions of the earphone case and earphones that forms no part of the claimed design.

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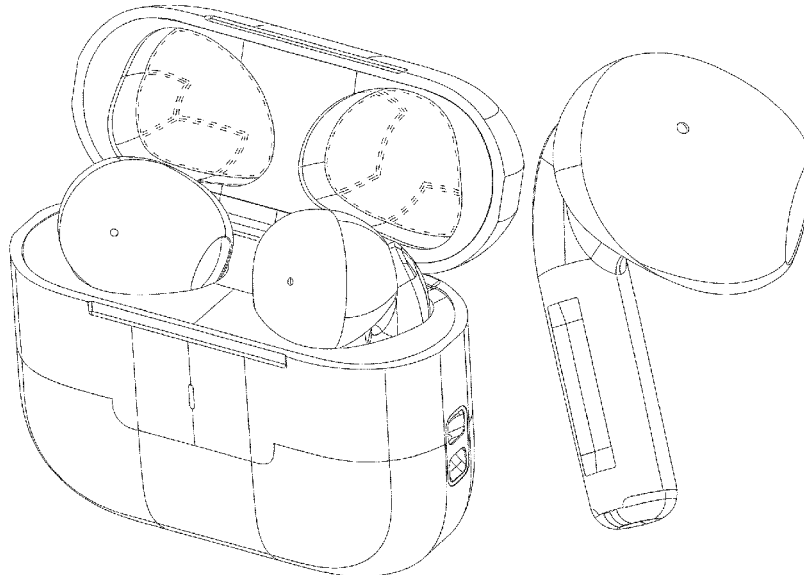
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1 Claim, 24 Drawing Sheets



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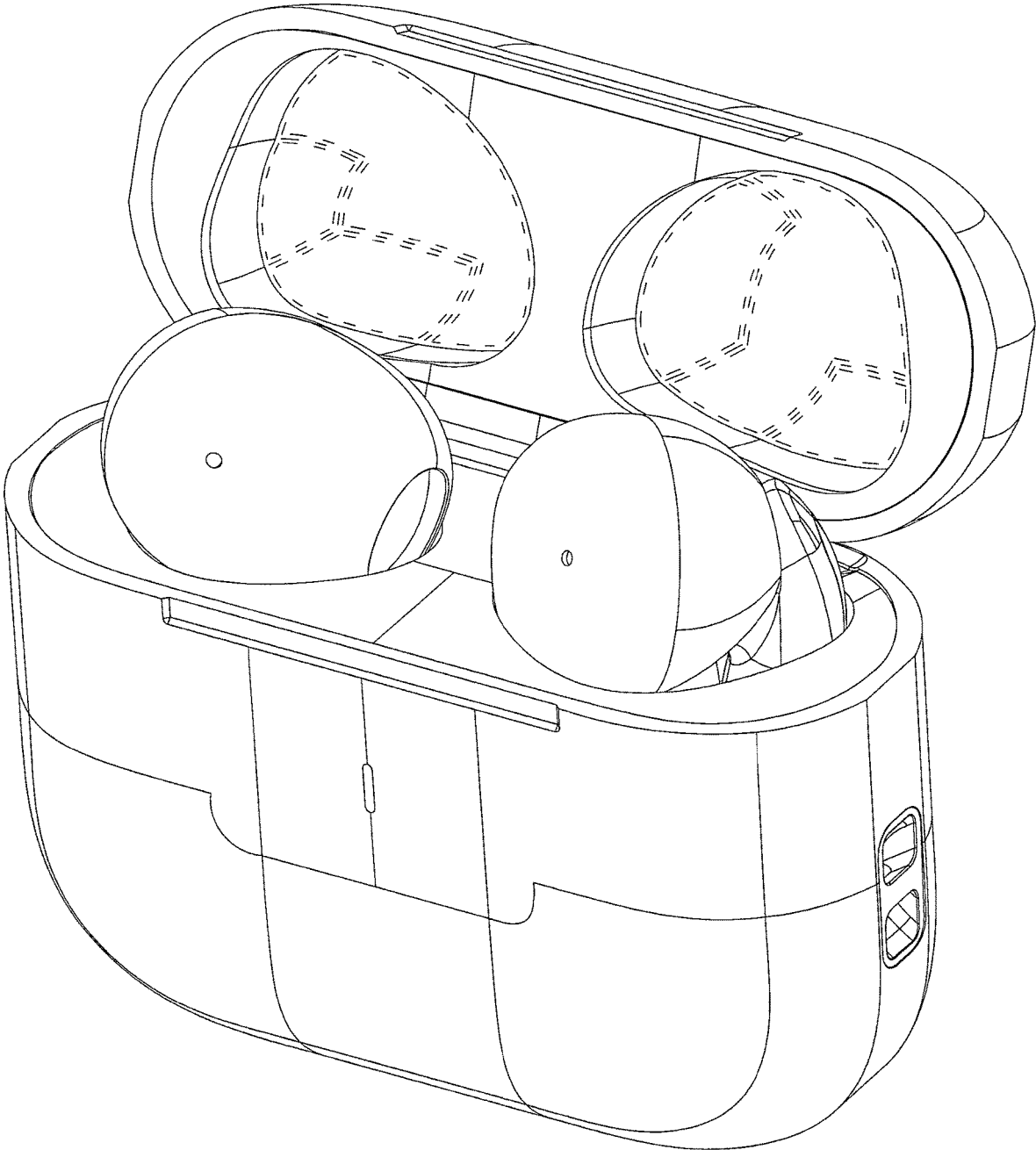


FIG. 1

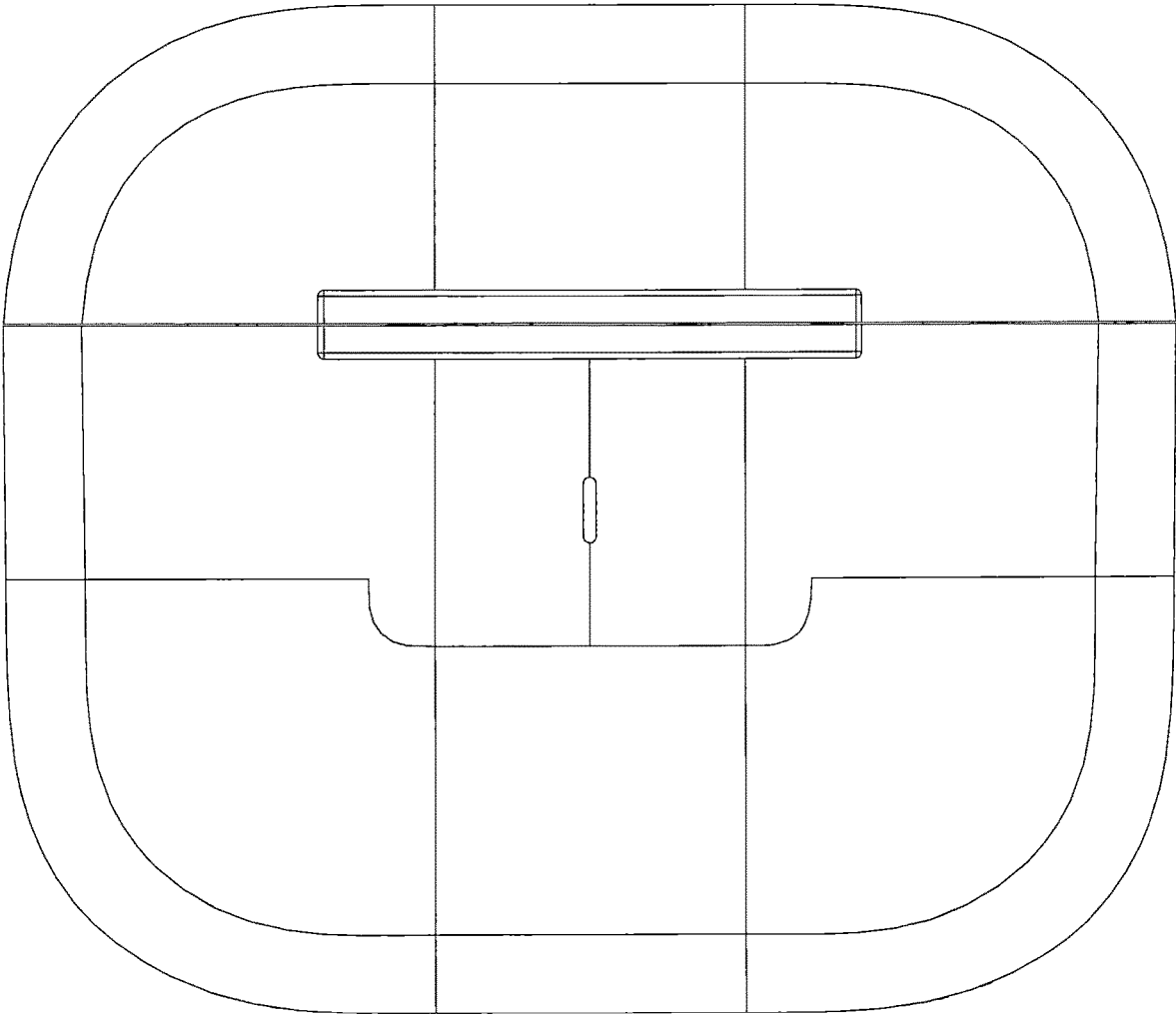


FIG. 2

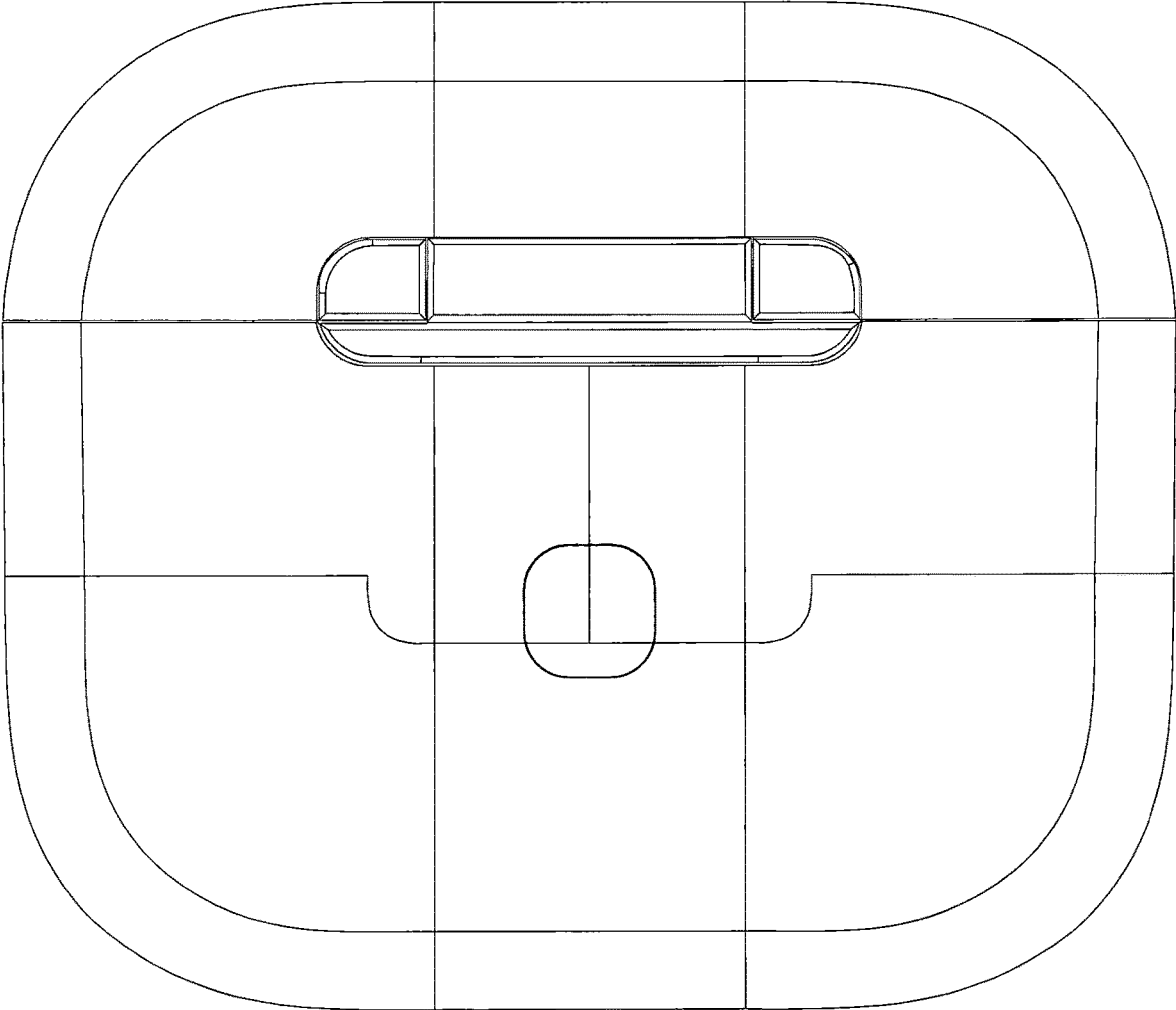


FIG. 3

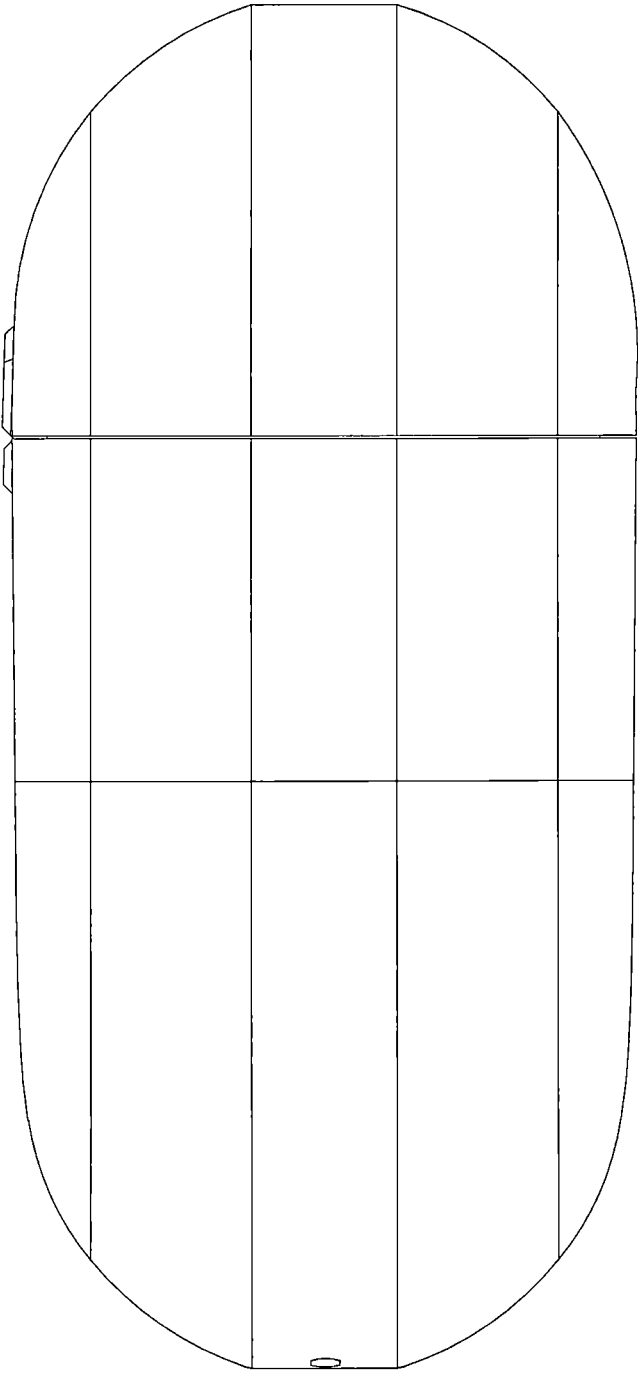


FIG. 4

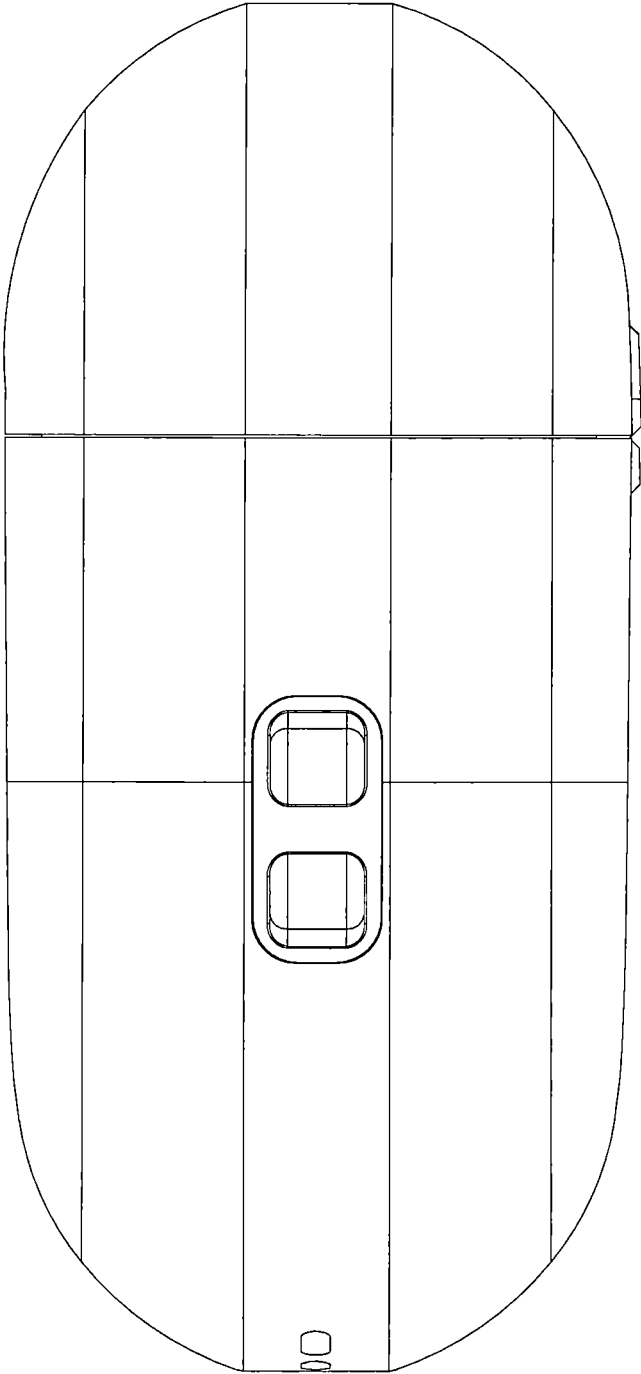


FIG. 5

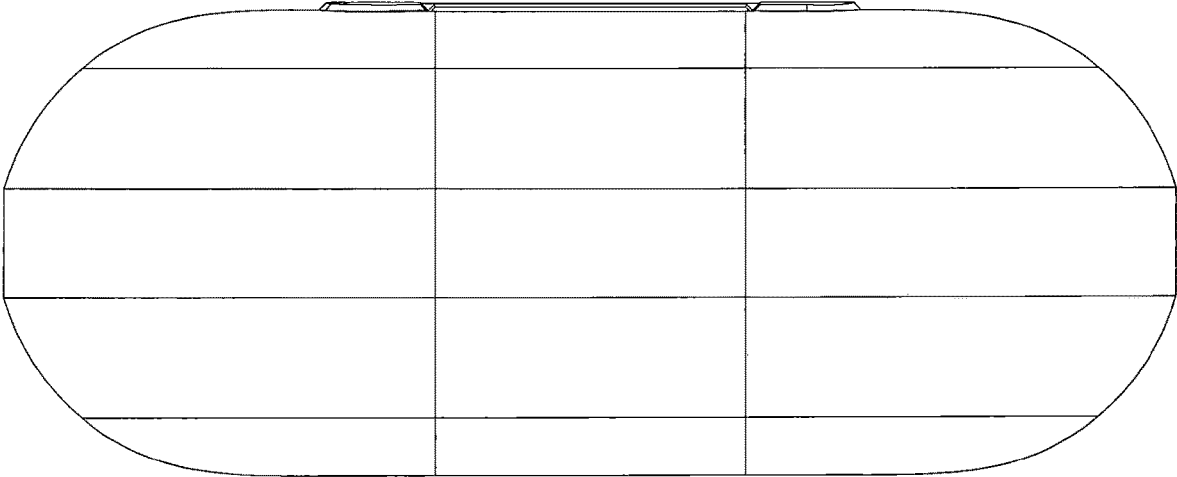


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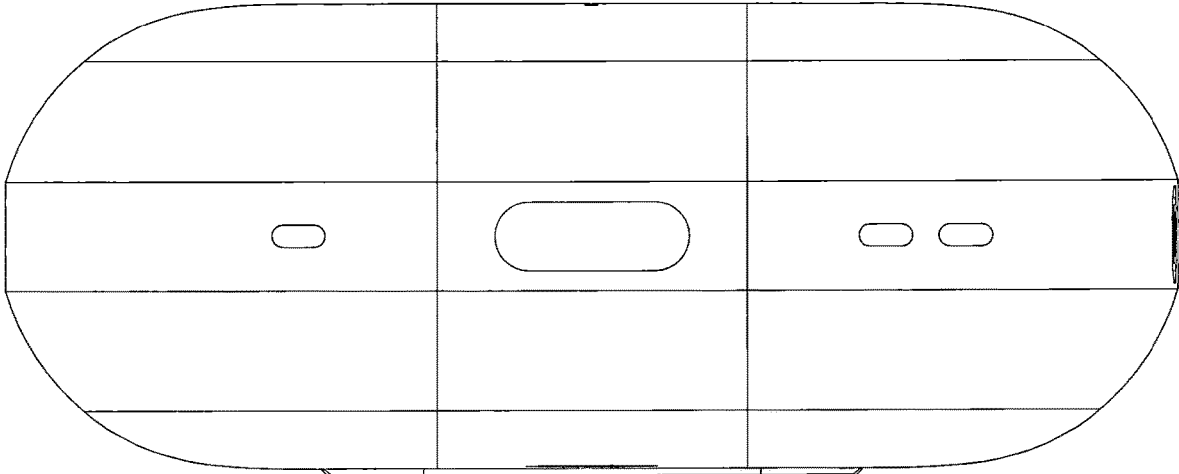


FIG. 7

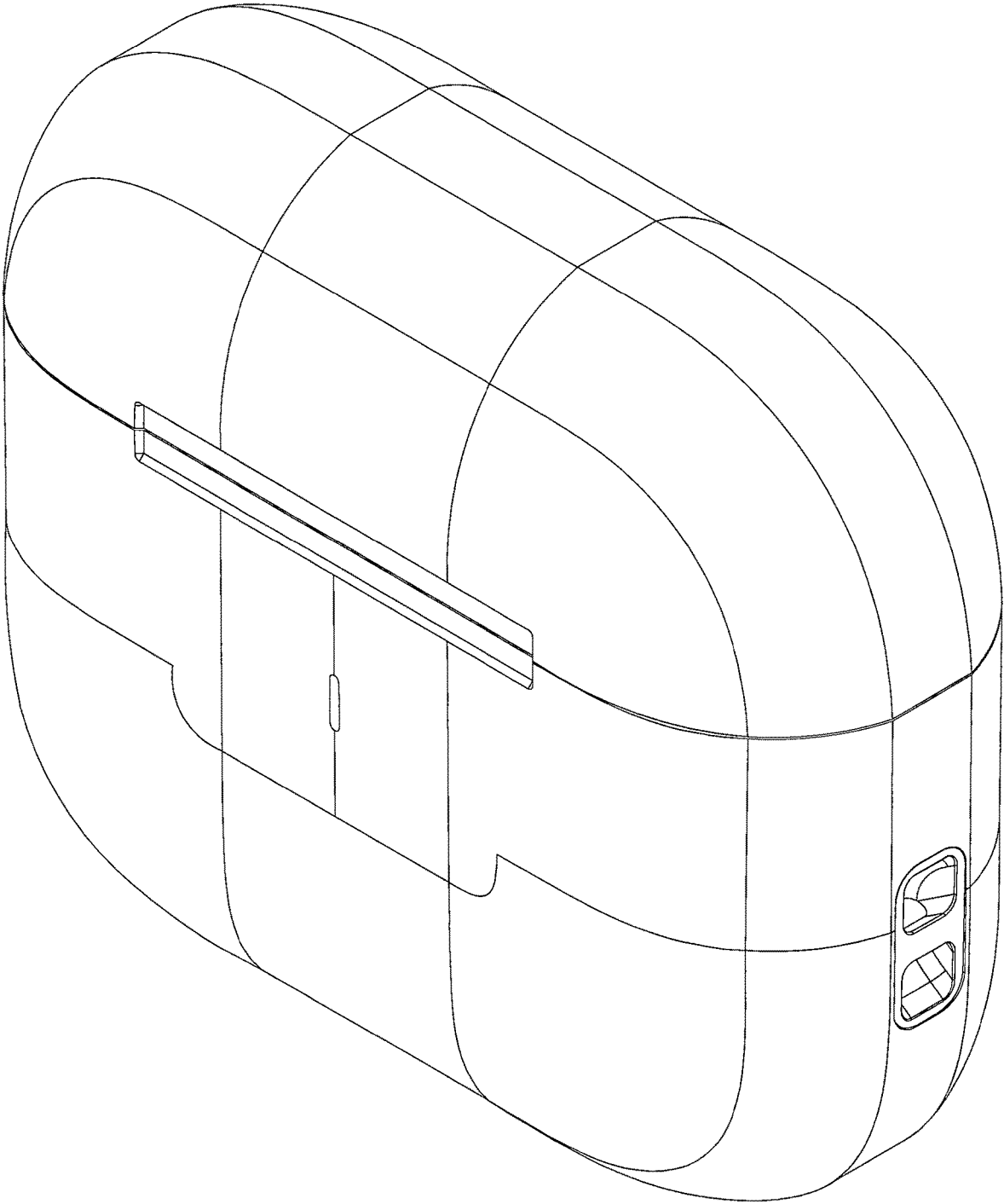


FIG. 8

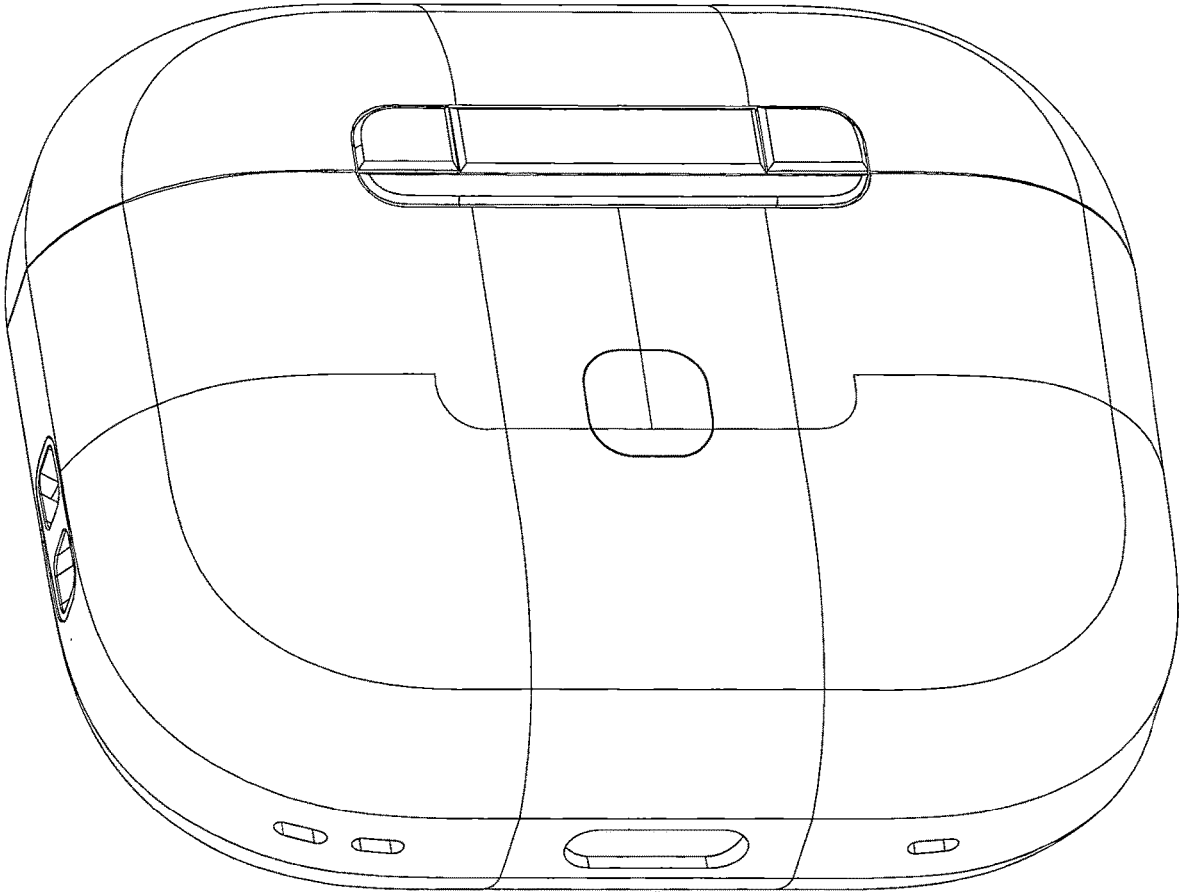


FIG. 9

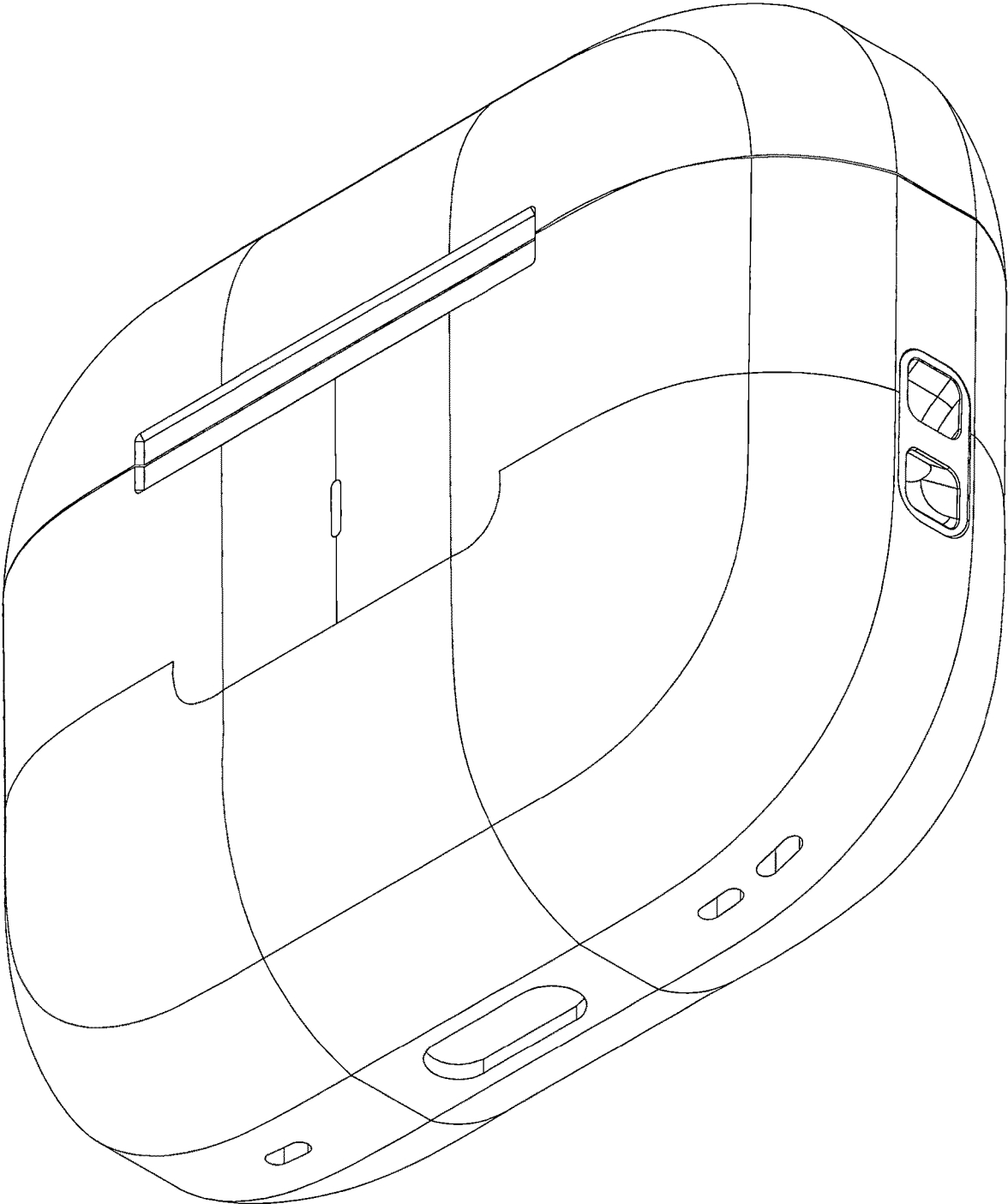


FIG. 10

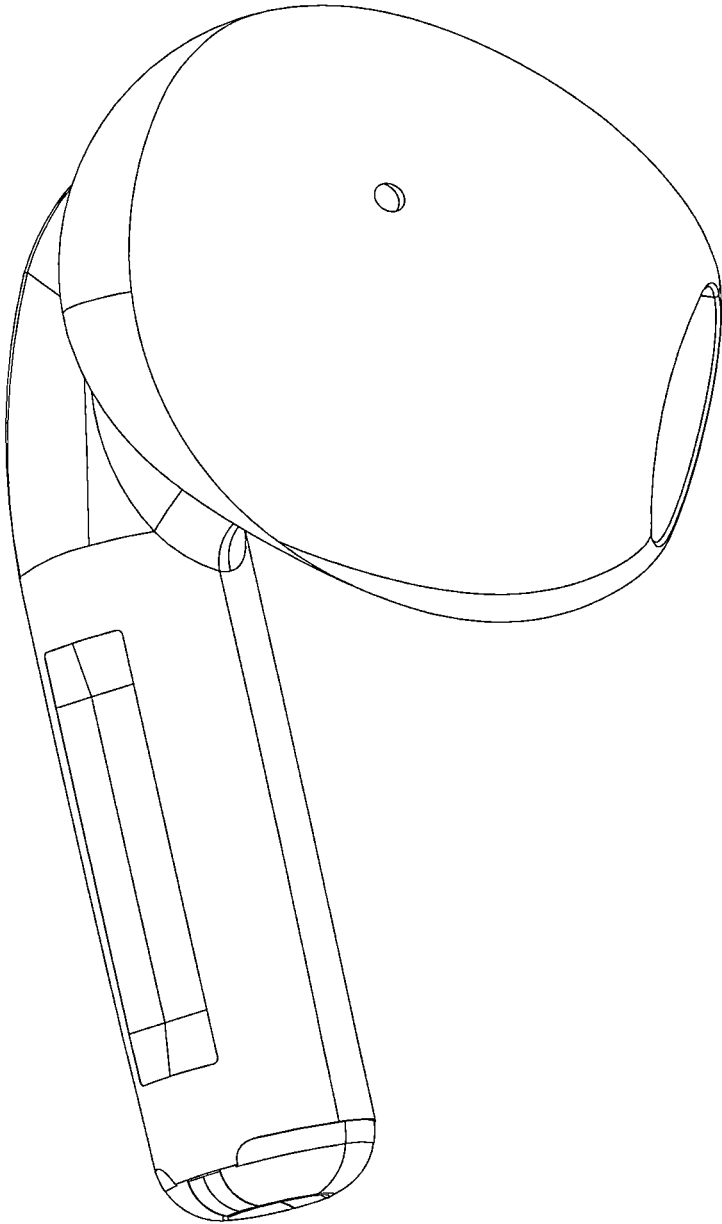


FIG. 11

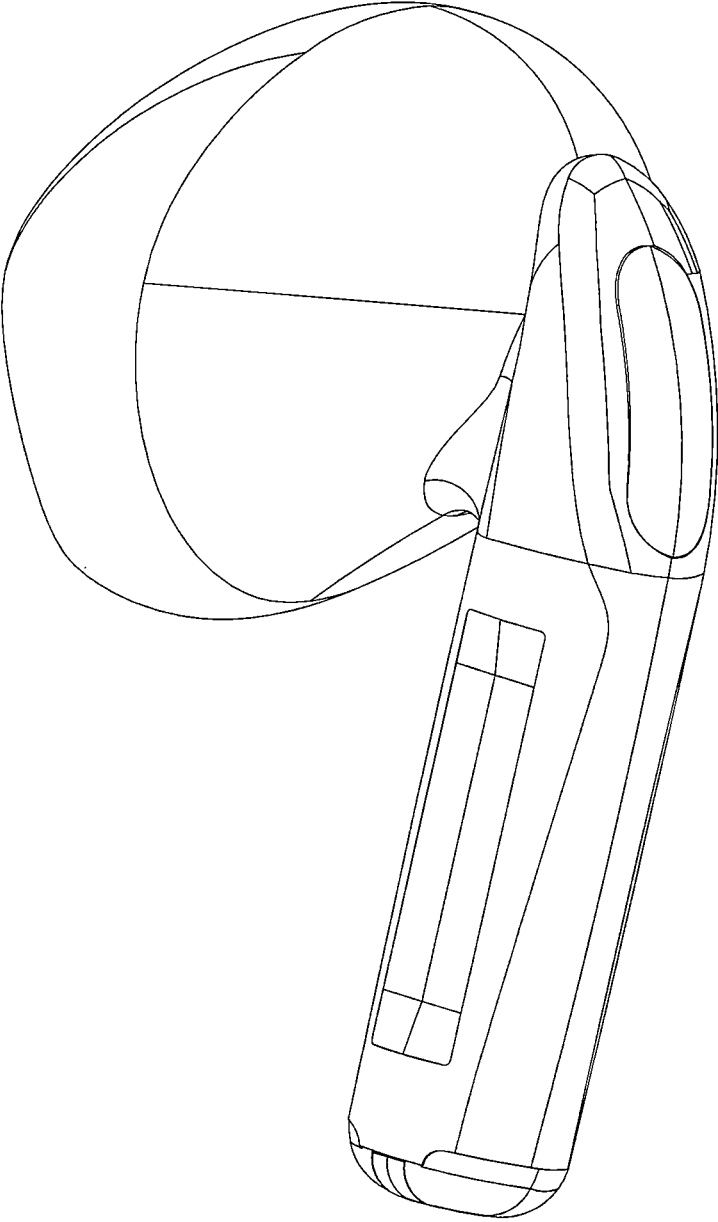


FIG. 12

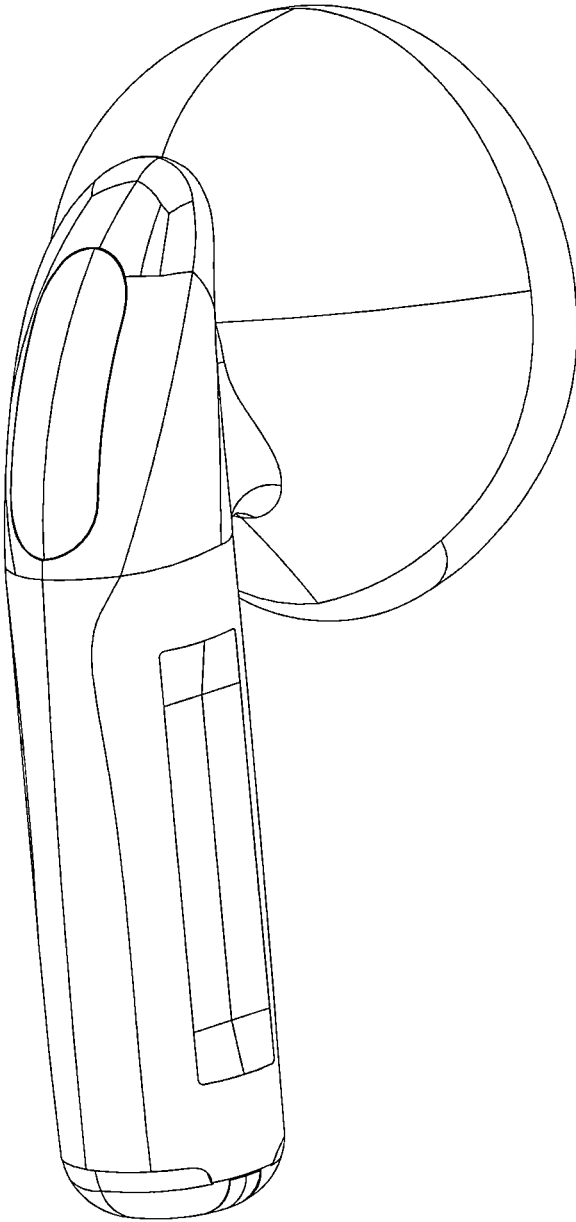


FIG. 13

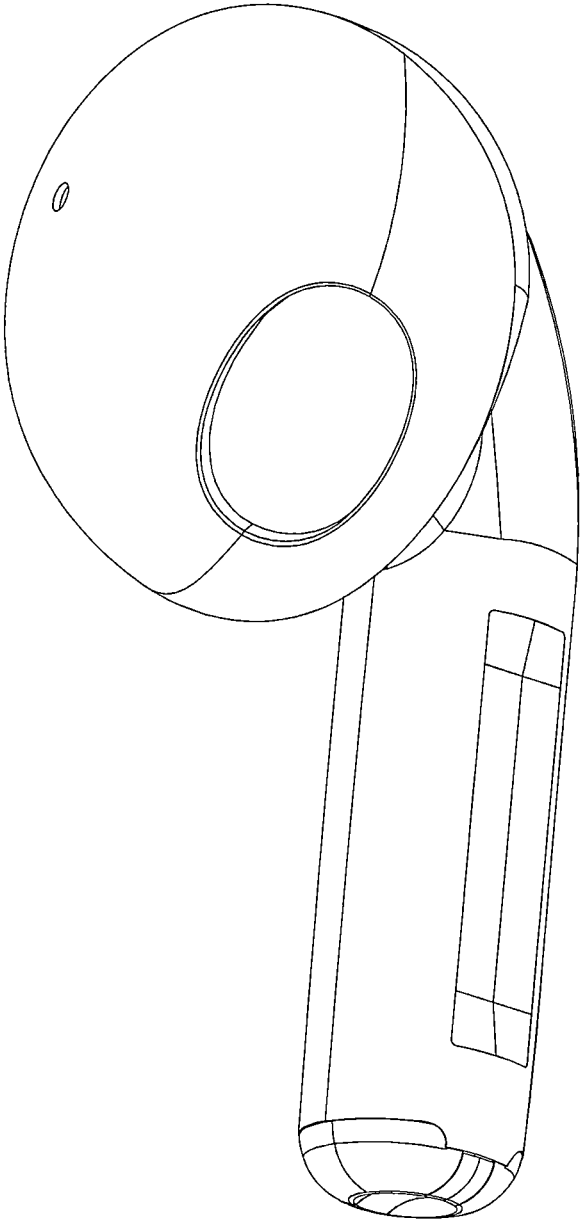


FIG. 14

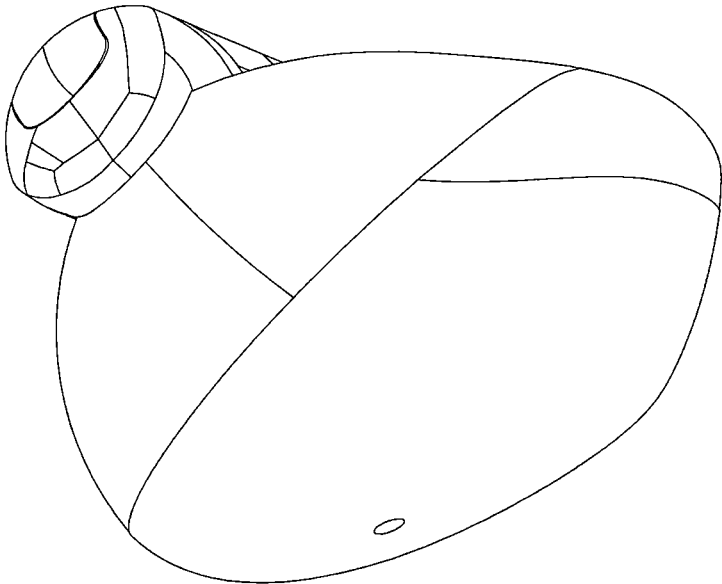


FIG. 15

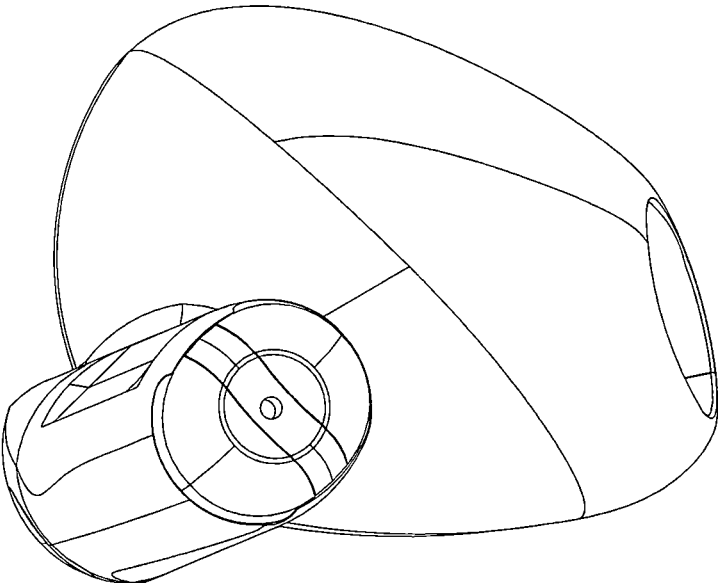


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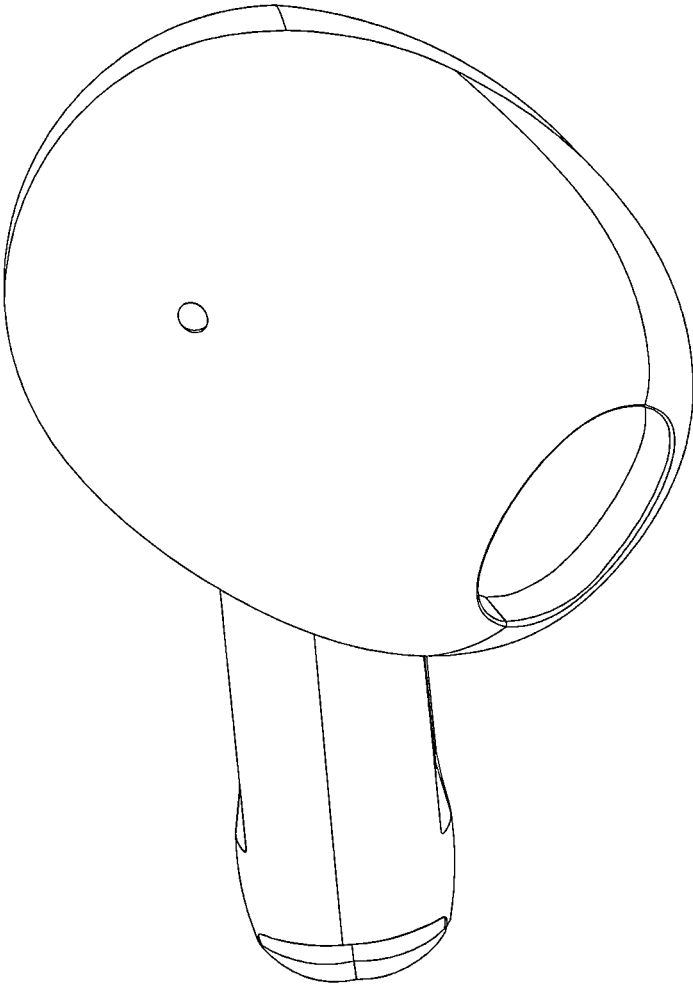


FIG. 17

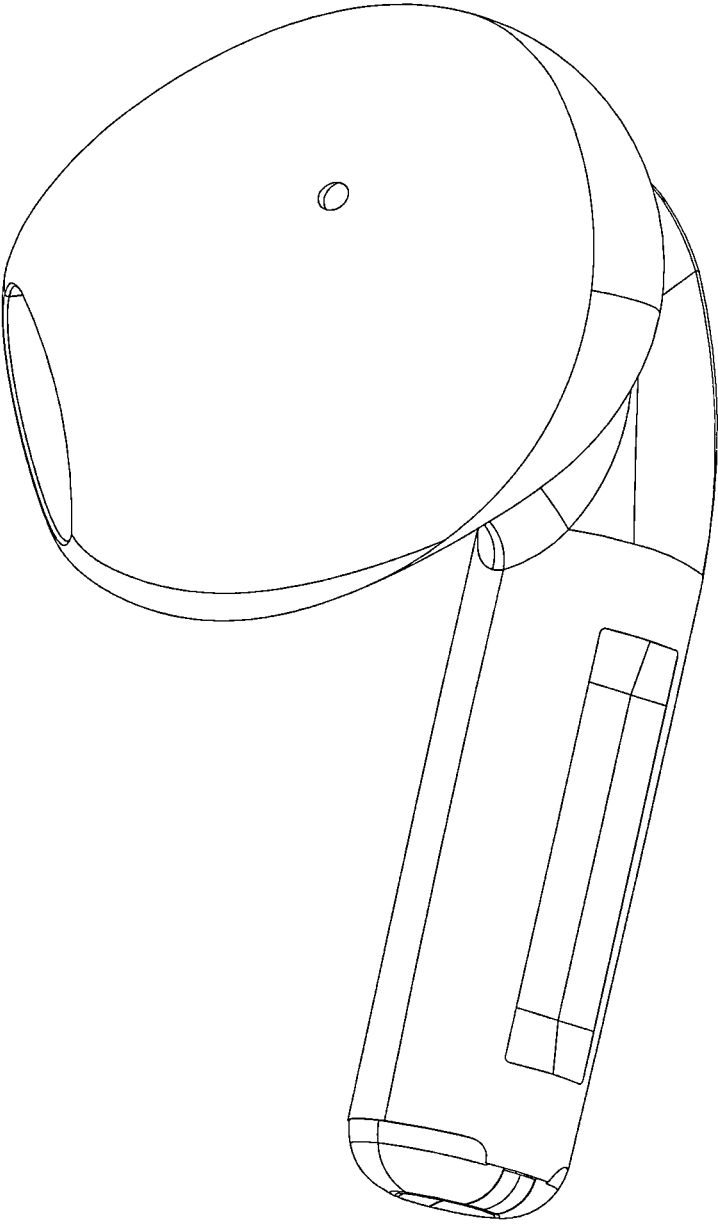


FIG. 18

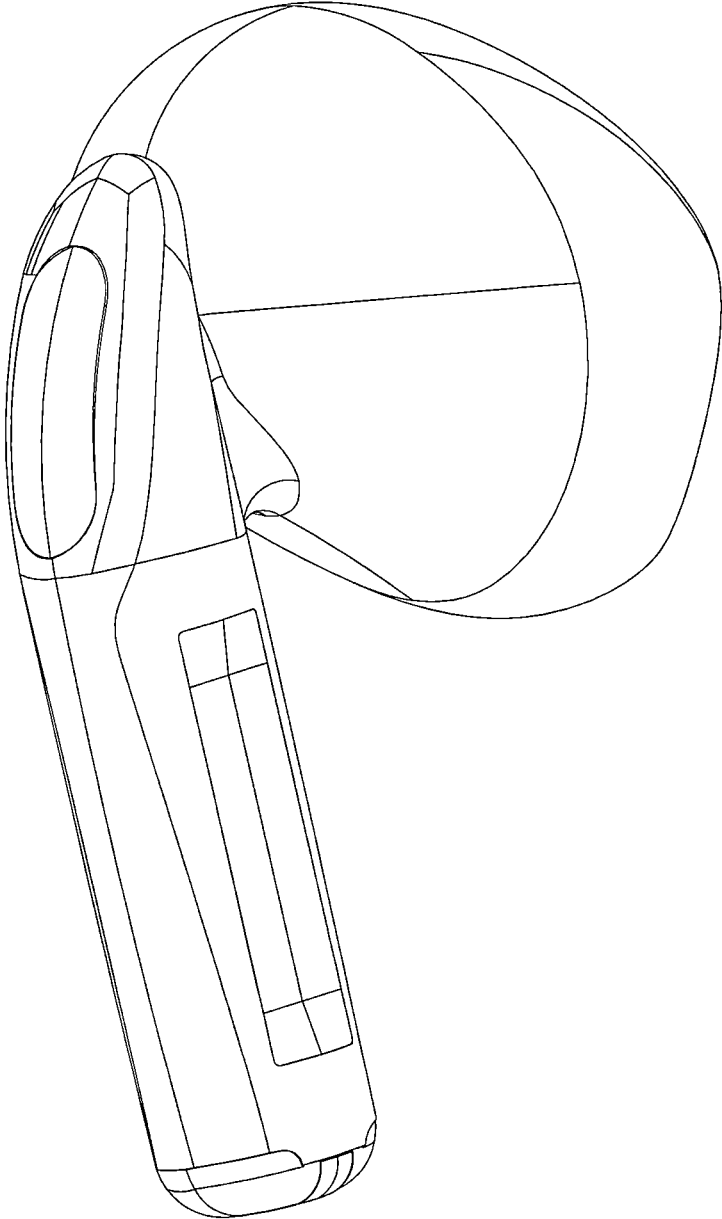


FIG. 19

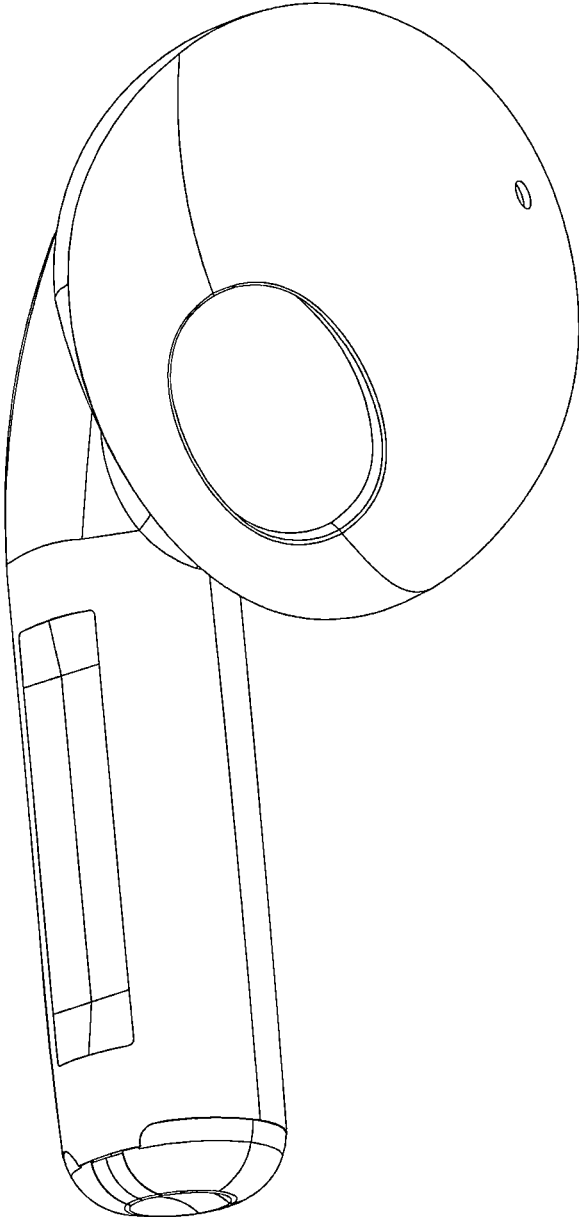


FIG. 20

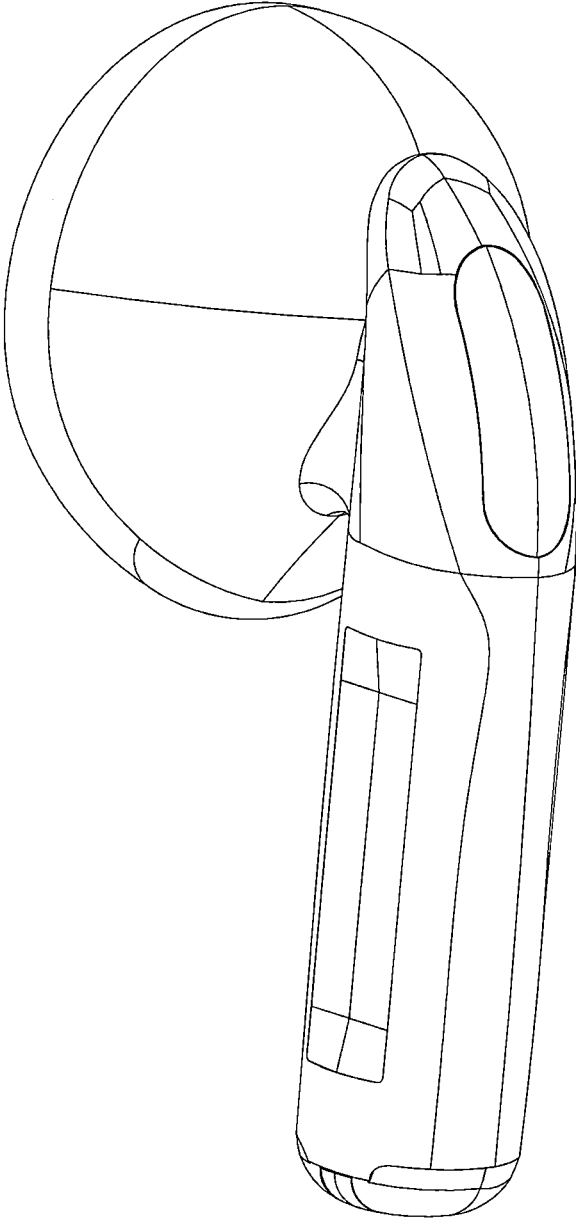


FIG. 21

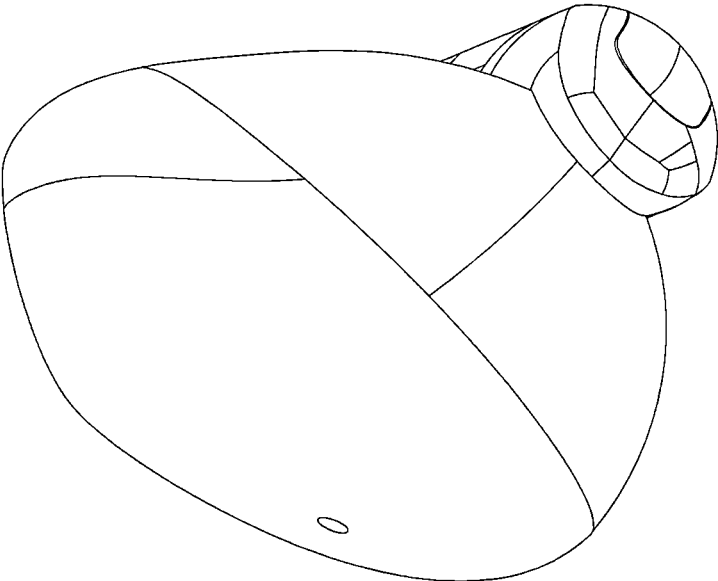


FIG. 22

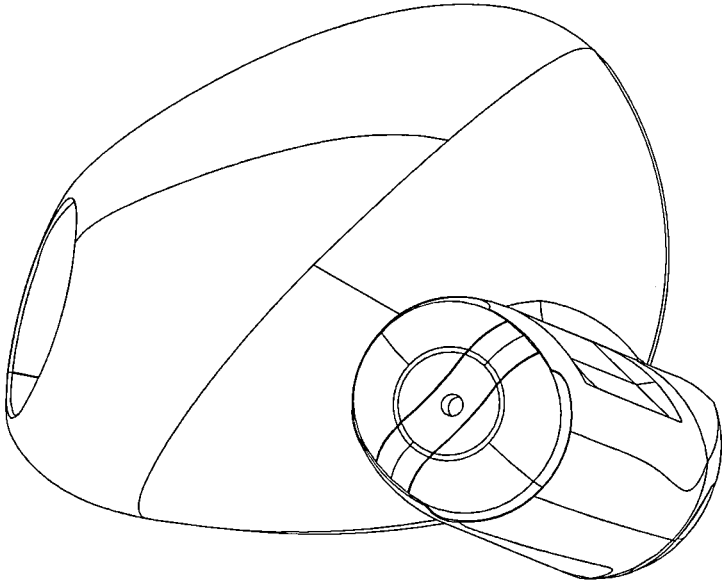


FIG. 23

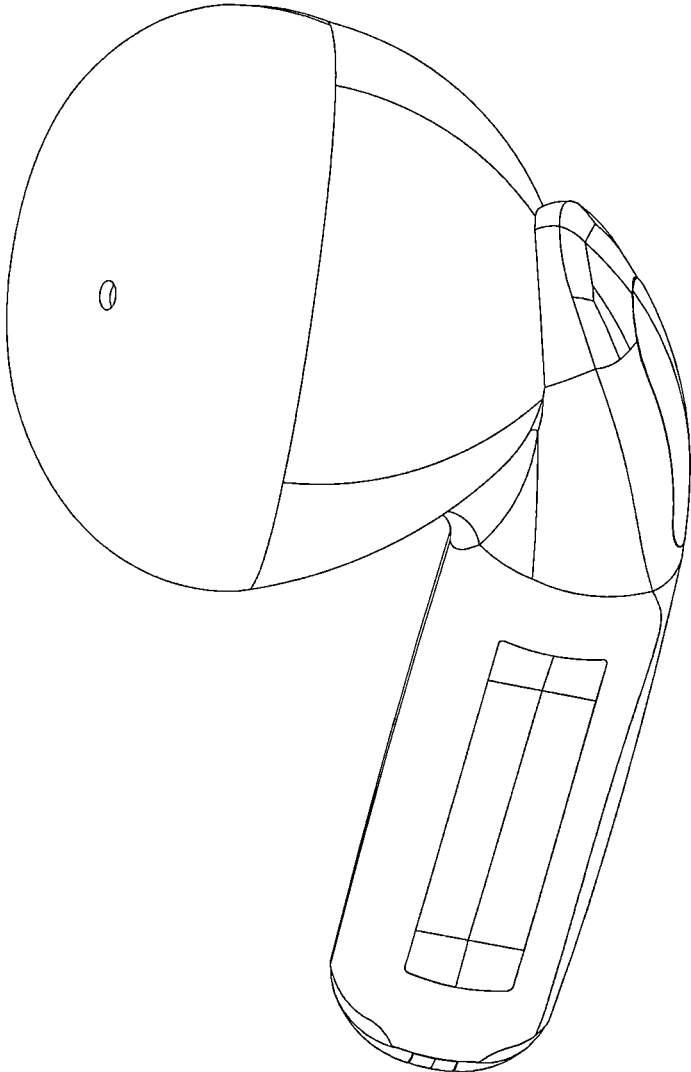


FIG. 24